



## **General Description**

The AOZ1361DI is a high-side load switch intended for applications that require circuit protection. The device operates from voltages between 4.5V and 28V. The internal current limiting circuit protects the input supply voltage from large load current. The current limit can be set with an external resistor. The AOZ1361DI provides thermal protection function that limits excessive power dissipation. The device employs internal soft-start circuitry to control inrush current due to highly capacitive loads associated with hot-plug events. It features low quiescent current of 220 $\mu$ A and the supply current reduces to less than 1 $\mu$ A in shutdown.

The AOZ1361DI is available in a 10-pin 4x4 DFN package and can operate over -40°C to +85°C temperature range.

## Features

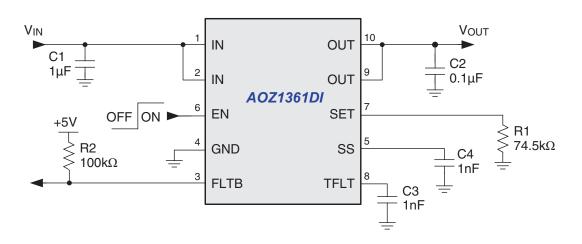
- 35mΩ maximum on resistance
- Programmable current limit
- 4.5V to 28V operating input voltage
- Low quiescent current
- Under-voltage lockout
- Thermal shutdown protection
- Open-drain fault indicator with delay
- Small 4x4 DFN package
- 2.5kV ESD rating

## Applications

- Notebook PCs
- Hot swap supplies



## **Typical Application**





## **Ordering Information**

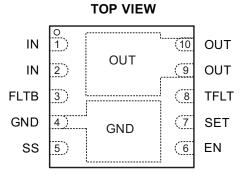
| Part Number  | Feature      | Package    | Temperature Range | Environmental                   |  |  |
|--------------|--------------|------------|-------------------|---------------------------------|--|--|
| AOZ1361DI-01 | Auto-restart | DFN 4x4 10 | -40°C to +85°C    | RoHS Compliant<br>Green Product |  |  |
| AOZ1361DI-02 | Latch-off    | DFN 4X4 10 | -40 C 10 +85 C    |                                 |  |  |



AOS Green Products use reduced levels of Halogens, and are also RoHS compliant.

Please visit www.aosmd.com/web/quality/rohs\_compliant.jsp for additional information.

## **Pin Configuration**



DFN 4x4 10

## **Pin Description**

| Pin Number | Pin Name | Pin Function  |  |  |  |  |
|------------|----------|---|--|--|--|--|
| 1, 2       | IN       | P-channel MOSFET source. Connect a 1µF capacitor from IN to GND.  |  |  |  |  |
| 3          | FLTB     | Fault output pin. This is an open drain output that is internally pulled low to indicate a fault condition. Connect to 5V or 3.3V through a pull up resistor. |  |  |  |  |
| 4          | GND      | Ground.   |  |  |  |  |
| 5          | SS       | Soft-Start Pin. Connect a capacitor from SS to GND to set the soft-start time.  |  |  |  |  |
| 6          | EN       | Enable Input.   |  |  |  |  |
| 7          | SET      | Current Limit Set Pin. Connect a resistor between SET and GND to set the switch current limit.  |  |  |  |  |
| 8          | TFLT     | Fault Delay pin. Connect a capacitor from TFLT to GND to set the Fault delay time.  |  |  |  |  |
| 9, 10      | OUT      | P-channel MOSFET Drain. Connect a 0.1µF capacitor from OUT to GND.  |  |  |  |  |



Absolute Maximum Ratings Exceeding the Absolute Maximum ratings may damage the device.

| Parameter                                      | Rating                         |
|--|--------------------------------|
| IN to GND                                      | -0.3V to +30V                  |
| EN, OUT to GND                                 | -0.3V to V <sub>IN</sub> +0.3V |
| FLTB, TFLT, SS, SET                            | -0.3V to +6V                   |
| Maximum Junction Temperature (T <sub>J</sub> ) | +150°C                         |
| ESD Rating (HBM)                               | 2.5kV                          |

## **Recommended Operating Conditions**

The device is not guaranteed to operate beyond the Maximum Recommended Operating Conditions.

| Parameter                    | Rating |  |  |  |  |
|------------------------------|--------|--|--|--|--|
| Thermal Resistance (DFN 4x4) | 63°C/W |  |  |  |  |

## **Electrical Characteristics**

 $V_{IN} = 12V$ ,  $T_A = 25^{\circ}C$  unless otherwise stated.

| Symbol                | Parameter                               | Conditions   | Min. | Тур.  | Max | Units  |
|-----------------------|---|--|------|-------|-----|--------|
| V <sub>IN</sub>       | Input Supply Voltage                    |  | 4.5  |       | 28  | V      |
| V <sub>UVLO</sub>     | Undervoltage Lockout<br>Threshold       | IN rising  |      | 3.9   | 4.4 | V      |
| V <sub>UVHYS</sub>    | Undervoltage Lockout<br>Hysteresis      |  |      | 200   |     | mV     |
| I <sub>IN_ON</sub>    | Input Quiescent Current                 | EN = IN, no load   |      | 300   | 500 | μA     |
| I <sub>IN_OFF</sub>   | Input Shutdown Current                  | EN = GND, no load  |      |       | 1   | μA     |
| I <sub>LEAK</sub>     | Output Leakage Current                  | EN = GND, no load  |      |       | 1   | μA     |
| R <sub>DS(ON)</sub>   | Switch On Resistance                    | V <sub>IN</sub> = 12V  |      | 22 35 | mΩ  |        |
|                       |   | V <sub>IN</sub> = 4.5V   |      | 33    | 43  | 1115.2 |
| I <sub>LIM</sub>      | Current Limit                           | $R_{SET} = 74.5 k\Omega$   | 2    | 2.7   | 3.4 | А      |
| V <sub>EN_L</sub>     | Enable Input Low Voltage                |  |      |       | 0.8 | V      |
| $V_{EN_H}$            | Enable Input High Voltage               |  | 2.0  |       |     | V      |
| V <sub>EN_HYS</sub>   | Enable Input Hysteresis                 |  |      | 100   |     | mV     |
| I <sub>EN_BIAS</sub>  | Enable Input Bias Current               |  |      |       | 1   | μA     |
| Td_on                 | Turn-On Delay Time<br>EN_50% to OUT_10% | $R_L$ =120 $\Omega$ , $C_L$ = 1 $\mu$ F, SS = Floated.<br>Measure from 50% of EN voltage to 10% of OUT voltage     |      | 280   |     | μs     |
| t <sub>ON</sub>       | Turn-On Rise Time<br>OUT_10% to 90%     | $R_L$ =120 $\Omega$ , $C_L$ = 1 $\mu$ F, SS = Floated.<br>Measure from 10% of OUT voltage<br>to 90% of OUT voltage |      | 220   |     | μs     |
|                       |   | $R_L$ =120 $\Omega$ , $C_L$ = 1 $\mu$ F, $C_{SS}$ = 1 $n$ F  |      | 360   |     | μs     |
| t <sub>OFF</sub>      | Turn-Off Fall Time                      | $R_L=120\Omega$ , $C_L=1\mu$ F, SS = Floated   |      | 280   |     | μs     |
| R <sub>DS(FLTB)</sub> | On-Resistance at FLTB                   | Sink current = 4mA   |      |       | 100 | Ω      |
| I <sub>LEAK_FLT</sub> | FLT Output Leakage                      |  |      |       | 1   | μA     |
| TFLT                  | FLT Delay Period                        | C <sub>TLT</sub> = 1nF   |      | 600   |     | μs     |
| T <sub>SD</sub>       | Thermal Shutdown Threshold              |  |      | 130   |     | °C     |
| T <sub>SD_HYS</sub>   | Thermal Shutdown Hysteresis             |  |      | 30    |     | °C     |



## **Timing Diagram**

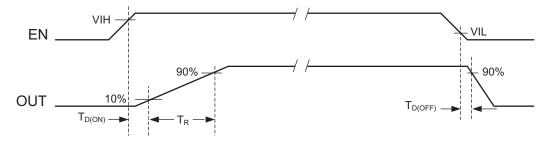


Figure 1. AOZ1361DI Timing

## **Functional Block Diagram**

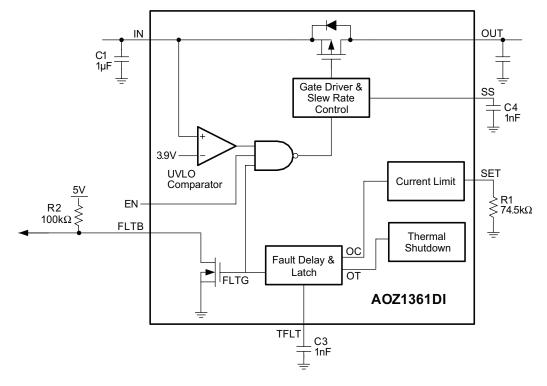
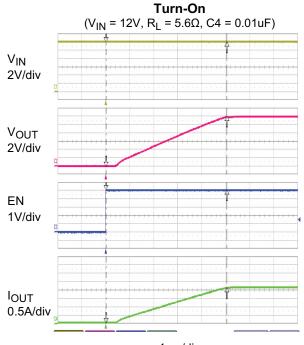


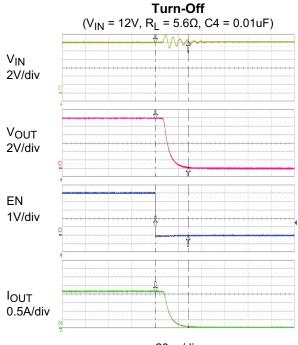
Figure 2. AOZ1361DI Functional Block Diagram



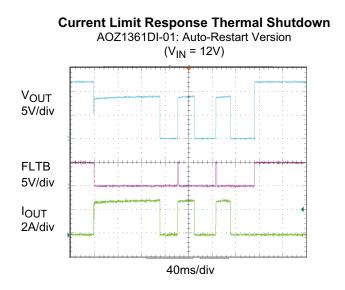
## **Functional Characteristics**



1ms/div



20µs/div



Current Limit Response Thermal Shutdown AOZ1361DI-02: Latch-off Version (V<sub>IN</sub> = 12V)

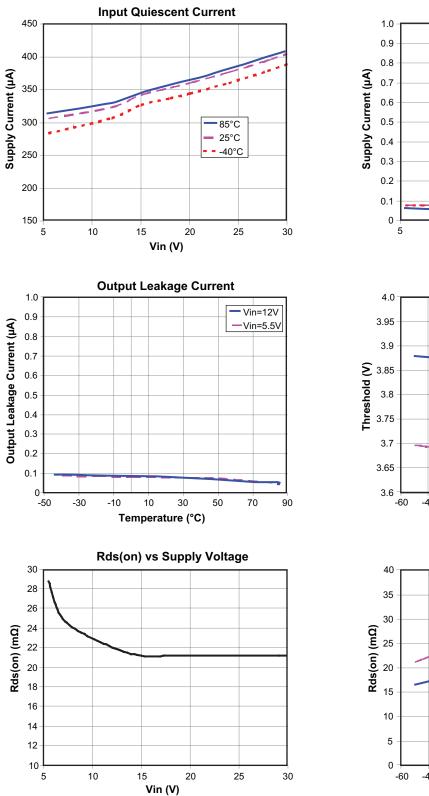
2ms/div

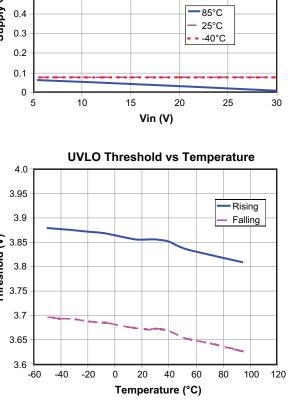
IOUT

2A/div

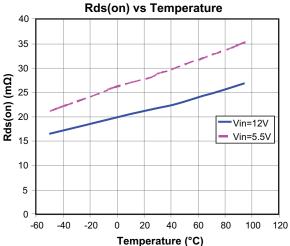


## **Typical Operating Characteristics**



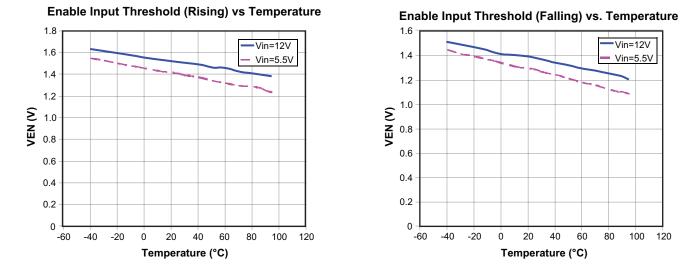


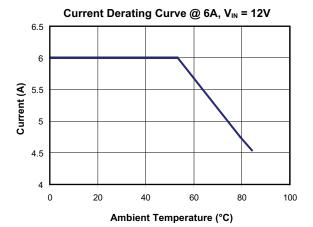
Input Shutdown Current





## Typical Operating Characteristics (Continued)







## **Detailed Description**

#### Introduction

The AOZ1361DI is a  $35m\Omega$  P-channel high-side load switch with adjustable soft-start slew-rate control, programmable current limit and thermal shutdown. It operates with an input voltage range from 4.5V to 28V.

#### Enable

The EN pin is the ON/OFF control for the output switch. The device is enabled when EN pin is high and VIN is above UVLO. The EN pin must be driven to a logic high or logic low state to guarantee operation. While disabled, the AOZ1361DI only draws about 1µA supply current.

#### Under-Voltage Lockout (UVLO)

The under-voltage lockout (UVLO) circuit of AOZ1361DI monitors the input voltage and prevents the output MOSFET from turning on until VIN exceeds 3.9V.

#### Adjustable Soft-Start Slew-Rate Control

When the EN pin is asserted high, the slew rate control circuitry applies voltage on the gate of the PMOS switch in a manner such that the output voltage and current is ramped up linearly until it reaches the steady-state load current level. The slew rate can be adjusted by an external capacitor connected to the SS pin to ground. The slew rate rise time, Ton, can be set using the following equation:

$$Ton = \frac{Css \times V_{IN}}{30\mu A}$$

#### **Programmable Current Limit**

The current limit is programmed by an external resistor connected to the SET pin to ground. This sets a reference voltage to the current limit error amplifier that compares it to a sensed voltage that is generated by passing a small portion of the load current through an internal amplifier. When the sensed load current exceeds the set current limit, the load current is then clamped at the set limit and the Vout drop should be the result of resistance increasing. The AOZ1361DI will stay in this condition until the load current no longer exceeds the current limit or if the thermal shutdown protection is engaged. To set the current limit use Figure 3 on the following page.

#### **Thermal Shut-down Protection**

The thermal overload protection of AOZ1361DI is engaged to protect the device from damage should the die temperature exceeds safe margins due to a short circuit, extreme loading or heating from external sources.

- AOZ1361DI-01 (Auto-restart version): During current limit or short circuit conditions, the PMOS resistance is increased to clamp the load current. This increases the power dissipation in the chip causing the die temperature to rise. When the die temperature reaches 130°C the thermal shutdown circuitry will shutdown the device. There is a 30°C hysterisis. The device will turn back on and go through soft start after the temperature drops below +100°C. The thermal shutdown will cycle repeatedly until the over temperature condition disappears or the enable pin is pulled LOW.
- AOZ1361DI-02 (Latch-off version): Thermal shut-down protection sets a fault latch and shuts off the internal MOSFET and asserts the FLTB output if the junction temperature exceeds +130°C. The AOZ1361DI can be re-enabled by toggling EN pin after the die temperature drops below +100°C.

#### FLTB

The FLTB pin is an open drain output that is asserted low when either an over-current, short-circuit or overtemperature condition occurs. To prevent false alarm, the AOZ1361DI implements a fault delay time for overtemperature, over-current and short-circuit fault conditions. The FLTB pin becomes high impedance when the fault conditions are removed. For AOZ1361DI-02, if the temperature is higher than +130°C, the device will latch off. After that, if temperature drops below +100°C, the FLTB pin will pull high, which means the fault condition has already been removed, although there is no output voltage due to latch off function. A pull-up resistor must be connected between FLTB to 5V or 3.3V to provide a logic signal.

#### TFLT

TFLT is a fault delay pin, and its delay time is adjustable by a capacitor connected from TFLT to GND. The delay time can be calculated by:

 $C_{TLT}$  (µs) = 600 µs / nF x  $C_{TFLT}$  (nF)



## **Applications Information**

#### Input Capacitor Selection

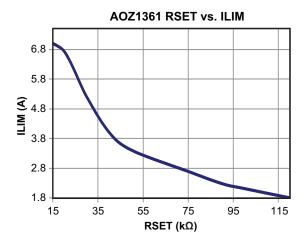
The input capacitor prevents large voltage transients from appearing at the input, and provides the instantaneous current needed each time the switch turns on and to limit input voltage drop. Also it is to prevent high-frequency noise on the power line from passing through the output of the power side. The choice of the input capacitor is based on its ripple current and voltage ratings rather than its capacitor value. The input capacitor should be located as close to the VIN pin as possible. A 1µF ceramic cap is recommended. However, higher capacitor values further reduce the voltage drop at the input.

#### **Output Capacitor Selection**

The output capacitor acts in a similar way. A small  $0.1\mu$ F capacitor prevents high-frequency noise from going into the system. Also, the output capacitor has to supply enough current for a large load that it may encounter during system transients. This bulk capacitor must be large enough to supply fast transient load in order to prevent the output from dropping.

#### **Current Limit Setting**

The current limit is program by using external resistor connected to the SET pin. To set the current limit, use the Figure 3 below.



#### Slew Rate Setting

Slew rate is set by changing the capacitor value on the SS pin of the device. A capacitor connected between this SS pin and ground will reduce the output slew-rate. The capacitive range is  $0.001\mu$ F to  $0.1\mu$ F. See Figure 4 for Output Slew Rate Adjustment vs. Capacitance.

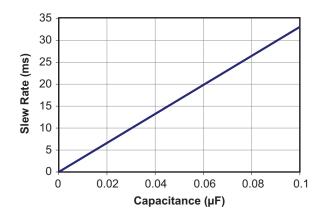


Figure 4. Output Slew Rate Adjustment vs. Capacitance

#### **Power Dissipation Calculation**

Calculate the power dissipation for normal load condition using the following equation:

$$P_{\rm D} = R_{\rm ON} \ x \ (I_{\rm OUT})^2$$

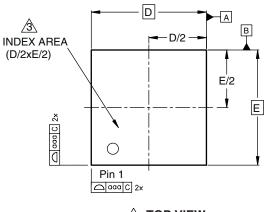
The worst case power dissipation occurs when the load current hits the current limit due to over-current or short circuit faults. The power dissipation under these conditions can be calculated using the following equation:

## $\mathsf{P}_\mathsf{D} = (\mathsf{V}_\mathsf{IN} - \mathsf{V}_\mathsf{OUT}) \times \mathsf{I}_\mathsf{LIMIT}$

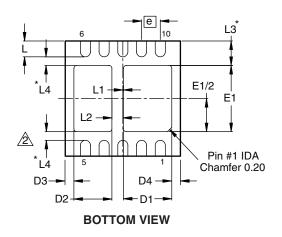
#### **Layout Guidelines**

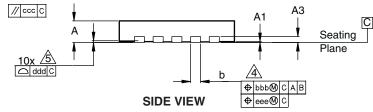
Good PCB layout is important for improving the thermal and overall performance of AOZ1361. To optimize the switch response time to output short-circuit conditions keep all traces as short as possible to reduce the effect of unwanted parasitic inductance. Place the input and output bypass capacitors as close as possible to the IN and OUT pins. The input and output PCB traces should be as wide as possible for the given PCB space. Use a ground plane to enhance the power dissipation capability of the device.

## Package Dimensions, DFN 4x4









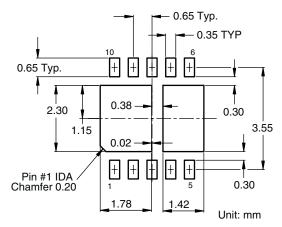
#### **Dimensions in millimeters**

#### Symbols Min. Nom. Max. А 0.70 0.75 0.80 A1 0.00 0.02 0.05 A3 0.203 REF b 0.30 0.35 0.40 D 3.95 4.00 4.05 D1 1.58 1.68 1.78 1.22 1.32 1.42 D2 D3 0.3 REF D4 0.3 REF Е 3.95 4.00 4.05 2.20 2.30 E1 2.40 0.65 BSC е L 0.50 0.55 0.60 0.02 0.12 L1 L2 0.28 0.38 0.48 L3 0.85 REF L4 0.30 REF 0.15 aaa 0.10 bbb ccc 0.10 ddd 0.08 0.05 eee

#### **Dimensions in inches**

| Dimensions in inches |                   |       |       |  |  |  |  |  |  |
|----------------------|-------------------|-------|-------|--|--|--|--|--|--|
| Symbols              | Min.              | Nom.  | Max.  |  |  |  |  |  |  |
| А                    | 0.028             | 0.030 | 0.031 |  |  |  |  |  |  |
| A1                   | 0.000             | 0.002 |       |  |  |  |  |  |  |
| A3                   | 0.008 REF         |       |       |  |  |  |  |  |  |
| b                    | 0.012 0.014 0.016 |       |       |  |  |  |  |  |  |
| D                    | 0.156             | 0.157 | 0.159 |  |  |  |  |  |  |
| D1                   | 0.062             | 0.066 | 0.070 |  |  |  |  |  |  |
| D2                   | 0.048             | 0.052 | 0.056 |  |  |  |  |  |  |
| D3                   | 0.012 REF         |       |       |  |  |  |  |  |  |
| D4                   | 0.012 REF         |       |       |  |  |  |  |  |  |
| E                    | 0.156             | 0.157 | 0.159 |  |  |  |  |  |  |
| E1                   | 0.087             | 0.091 | 0.094 |  |  |  |  |  |  |
| е                    | 0.026 BSC         |       |       |  |  |  |  |  |  |
| L                    | 0.020 0.022 0.02  |       |       |  |  |  |  |  |  |
| L1                   | —                 | 0.001 | 0.005 |  |  |  |  |  |  |
| L2                   | 0.011             | 0.015 | 0.019 |  |  |  |  |  |  |
| L3                   | 0.033 REF         |       |       |  |  |  |  |  |  |
| L4                   | 0.012 REF         |       |       |  |  |  |  |  |  |
| aaa                  | 0.006             |       |       |  |  |  |  |  |  |
| bbb                  | 0.004             |       |       |  |  |  |  |  |  |
| CCC                  | 0.004             |       |       |  |  |  |  |  |  |
| ddd                  | 0.003             |       |       |  |  |  |  |  |  |
| eee                  | 0.002             |       |       |  |  |  |  |  |  |

#### **RECOMMENDED LAND PATTERN**



#### Notes:

1. All dimensions are in millimeters.

2. The dimensions with \* are just for reference.

3. The location of the terminal #1 identifier and terminal numbering convention conforms to JEDEC publication 95 SPP-002.

A. Dimension b applies to metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip. If the terminal has the optional radius on the other end of the terminal, then dimension b should not be measured in that radius area.

 $\sqrt{5}$ . Coplanarity applies to the terminals and all other bottom surface metallization.

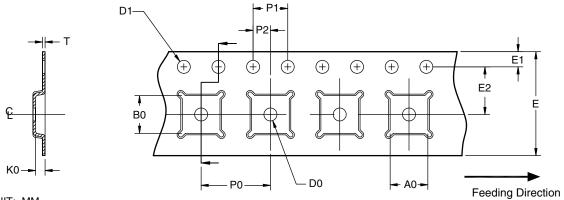
6 Drawings shown are for illustration only.

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## Tape and Reel Dimensions, DFN 4x4

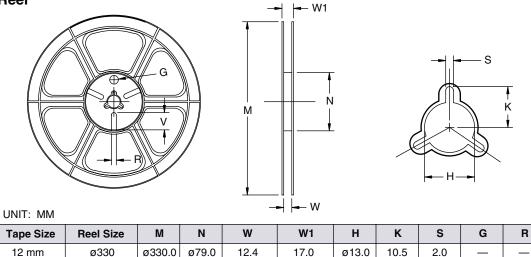
## **Carrier Tape**



UNIT: MM

| Package | A0   | B0   | К0   | D0   | D1        | Е    | E1   | E2   | P0   | P1   | P2   | Т    |
|---------|------|------|------|------|-----------|------|------|------|------|------|------|------|
| DFN 4x4 | 4.35 | 4.35 | 1.10 | 1.50 | 1.50      | 12.0 | 1.75 | 5.50 | 8.00 | 4.00 | 2.00 | 0.30 |
| (12mm)  | 0.10 | 0.10 | 0.10 | Min. | +0.1/-0.0 | 0.3  | 0.10 | 0.05 | 0.10 | 0.10 | 0.05 | 0.05 |

Reel

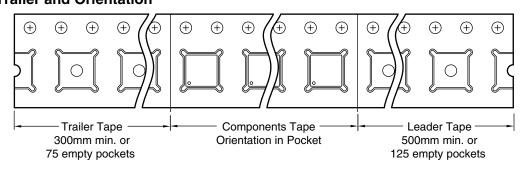


+2.0/-0.0

# Leader/Trailer and Orientation

2.0

1.0



+2.6/-0.0

0.5

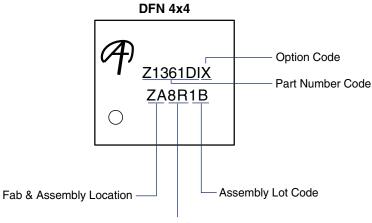
0.2

0.5

v



## **Part Marking**



Year & Week Code

#### Alpha & Omega Semiconductor reserves the right to make changes at any time without notice.

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